

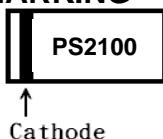
RoHS Compliant Product

A suffix of “-C” specifies halogen-free and RoHS Compliant

FEATURES

- Heatsink Structure
- Low Profile, Typical Thickness 0.8mm
- Super Low VF Schottky Barrier Diodes
- Moisture Sensitivity: Level 1, per J-STD-020
- High Temperature Soldering Guaranteed: 260°C/10 seconds

MARKING



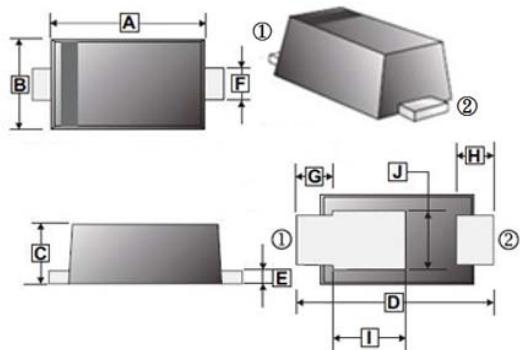
PACKAGE INFORMATION

Package	MPQ	Leader Size
SOD-123DT	3K	7 inch

ORDER INFORMATION

Part Number	Type
SM2100DT	Lead (Pb)-free
SM2100DT-C	Lead (Pb)-free and Halogen-free

SOD-123DT



REF.	Millimeter		REF.	Millimeter	
	Min.	Max.		Min.	Max.
A	2.9	3.1	F	0.85	1.05
B	1.9	2.1	G	0.6	REF.
C	0.75	0.9	H	0.4	0.85
D	3.5	3.9	I	1.66	REF.
E	0.1	0.25	J	1.3	1.7

① Cathode ② Anode

MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS ($T_A=25^\circ\text{C}$ unless otherwise specified)

Parameter	Symbol	Ratings		Unit
Maximum Repetitive Peak Reverse Voltage	V_{RRM}	100		V
Maximum RMS Voltage	V_{RMS}	70		V
Maximum DC Blocking Voltage	V_{DC}	100		V
Maximum Average Forward Rectified Current	I_F	2		A
Peak Forward Surge Current @8.3ms Single Half Sine-Wave Superimposed on Rate Load	I_{FSM}	50		A
Rating for Fusing ($t < 8.3\text{ms}$)	I^2t	10		A^2s
Maximum Instantaneous Forward Voltage @ $I_F=2\text{A}$	V_F	0.8		V
		0.65		
Maximum DC Reverse Current @ Rated DC Blocking Voltage	I_R	5		μA
		500		
Typical Junction Capacitance	C_J	60		pF
Typical Thermal Resistance from Junction-Ambient ¹	$R_{\theta JA}$	65		$^\circ\text{C/W}$
Typical Thermal Resistance from Junction-Case ²	$R_{\theta JC}$	35		
Typical Thermal Resistance from Junction-Lead ¹	$R_{\theta JL}$	9		
Operating Junction and Storage Temperature	T_J, T_{STG}	-55~150		$^\circ\text{C}$

Notes:

1. The thermal resistance from junction-ambient or lead, mounted on P.C.B with 5x5mm copper pads, 2OZ, FR4 PCB.
2. The thermal resistance from junction-case, mounted on P.C.B with recommended copper pads, 2OZ, FR4 PCB.

CHARACTERISTIC CURVES

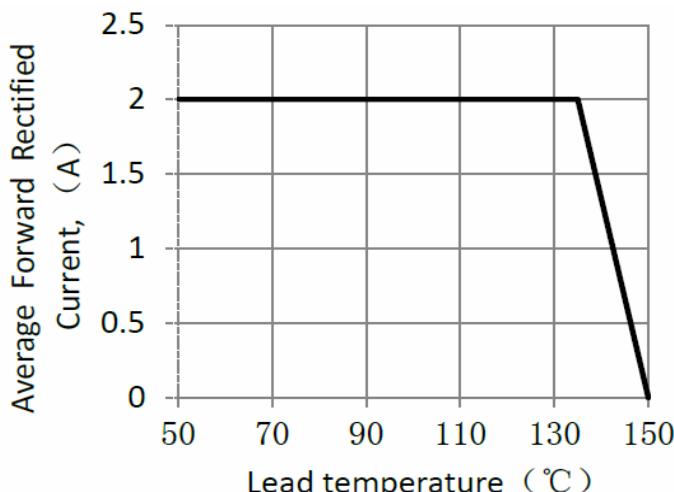


Figure 1. Forward Current Derating Curve

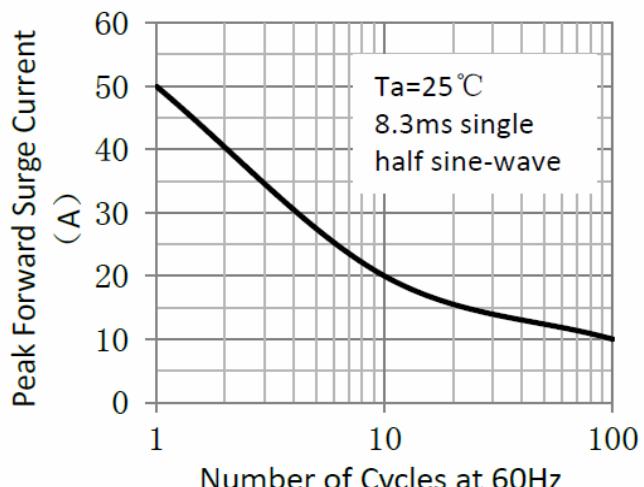


Figure 2. Maximum Non-Repetitive Peak Forward Surge Current

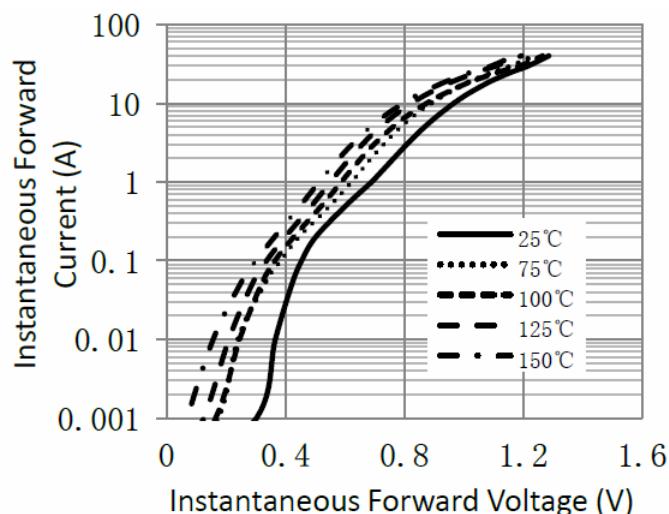


Figure 3. Typical Instantaneous Forward Characteristics

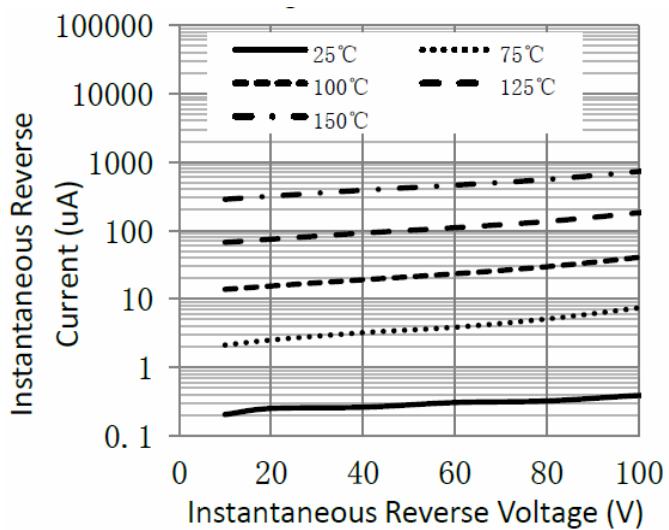


Figure 4. Typical Reverse Characteristics

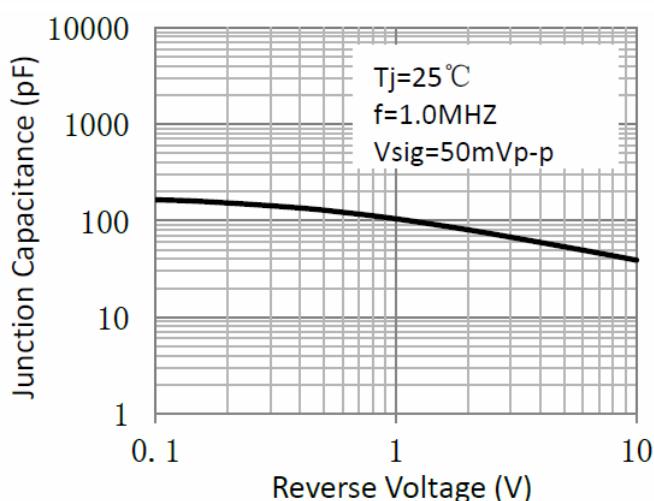


Figure 5. Typical Junction Capacitance